L Number	Hits	Search Text	DB	Time stamp
-	4	gale.in. & kern.in. & syverson.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/31 07:32
-	6	(("6036785") or ("5451295") or ("4491484")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/17 16:42
-	1	"63-155729"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/17 16:45
-	1	63-155729	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/17 16:45
-	20	"155729"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/17 16:47
-	1	"freeze water around foreign matter"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/17 16:48
-	6	(("6036785") or ("5451295") or ("4491484")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/25 16:05
-	3	(("6036785") or ("5451295") or ("4491484")).PN.	USPAT	2003/03/25 16:05
-	2	("5451295").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 14:24
-	1	"4119483".PN.	USPAT	2003/03/28 14:22
-	1	"4448636".PN.	USPAT	2003/03/28 14:22
-	1	"4519872".PN.	USPAT	2003/03/28 14:22
-	1	"4586980".PN.	USPAT	2003/03/28 14:22
-	1	"5275689".PN.	USPAT	2003/03/28 14:22
-	1	("4491484").PN.	USPAT	2003/03/28 14:24
-	30	"4491484"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 14:24
-	3	wafer and "4491484"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 14:26
-	30	"4491484"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 14:56
-	12	ultrasonic near10 (frozen ice) near22 removal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 15:02

-	2	("5724186").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 16:03
-	1	"5475530".PN.	USPAT	2003/03/28 15:02
-	1	"5076854".PN.	USPAT	2003/03/28 15:03
-	9	cryogenic near3 clean$3 and dioxide and ice and (sonic ultrasonic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 16:08
-	1	cryogenic near3 clean$3 and dioxide and (frozen ice) near12 layer and (sonic ultrasonic) near22 remov$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 16:10
-	3	cryogenic near3 clean$3 and (frozen ice) near4 layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 16:13
-	1125	clean$3 and (frozen ice) near4 layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 16:13
-	214	cryogenic and (frozen ice) near4 layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 16:15
-	46	cryogenic and (frozen ice) near4 layer and (substrate wafer semiconductor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 16:17
-	2	(("6095776") or ("6206636")).PN.	USPAT	2003/03/31 07:40
-	2	(("6095776") or ("6206636")).PN.	USPAT	2003/03/31 07:41
-	6	(("4666283") or ("6095776") or ("6206636")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/31 07:41
-	3	(("4666283") or ("6095776") or ("6206636")).PN.	USPAT	2003/03/31 08:02
-	4	(("4666283") or ("6095776") or ("6206636") or ("6116855")).PN.	USPAT	2003/03/31 08:02
-	2	("5724186").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/31 11:13
-	1		USPAT	2003/08/14 10:12
-	1		USPAT	2003/08/14 10:13